

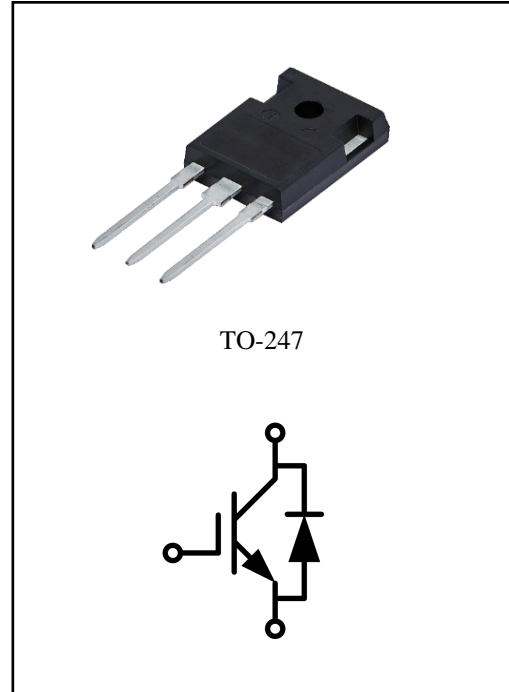
IGBT Discrete with Anti-Parallel Diode

Features :

- 650V Trench /Field Stop type
- Low switching losses
- V_{cesat} has a positive temperature coefficient

Applications:

- Charging station
- Uninterruptible power supplies
- Inverters



IGBT

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter Voltage	$T_{vj}=25^{\circ}C$	V_{CES}	650	V
Continuous DC collector current	$T_C=25^{\circ}C, T_{vj\ max}=175^{\circ}C$ $T_C=100^{\circ}C, T_{vj\ max}=175^{\circ}C$	I_C	80 75	A
Pulsed collector current, tp limited by $T_{vj\ max}$		I_{Cpuls}	225	A
Total power dissipation	$T_C=25^{\circ}C, T_{vj\ max}=175^{\circ}C$ $T_C=100^{\circ}C, T_{vj\ max}=175^{\circ}C$	P_{tot}	441 220	W

Gate emitter Voltage	$t_p \leq 10\mu s, D < 0.010$	V_{GE}	± 20 ± 30	V
Temperature under switching conditions		$T_{vj\ op}$	-40...+175	°C
Storage temperature		T_{stg}	-40...+150	°C

Thermal Characteristics

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction-ambient		$R_{th(j-a)}$			65	K/W
IGBT thermal resistance, junction - case		$R_{th(j-c)}$		0.34		K/W
Diode thermal resistance, junction - case		$R_{th(j-c)}$		0.49		K/W

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	$V_{GE}=0V, I_C=0.25mA$	$V_{(BR)CES}$	650			V
Collector-Emitter saturation Voltage	$V_{GE}=15V, I_C=75A$ $V_{GE}=15V, I_C=75A$ $V_{GE}=15V, I_C=75A$	V_{CEsat}		1.63 2.03 2.13	2.10	
Gate-Emitter threshold Voltage	$I_C=0.75mA, V_{GE}=V_{CE}$ $T_{vj}=25^\circ C$	$V_{GE(th)}$	4.2	5.1	6.0	
Transconductance	$V_{CE}=20V, I_C=75A$	G_{fs}		91		S
Input capacitance	$f=1\ MHz, V_{CE}=25V, V_{GE}=0V$ $T_{vj}=25^\circ C$	C_{ies}		7.44		nF
Output capacitance		C_{oes}		0.24		
Reverse transfer capacitance		C_{res}		0.13		
Gate charge	$I_C=75A, V_{GE}=15V,$ $V_{CE}=520V$ $T_{vj}=25^\circ C$	Q_G		0.74		μC
Collector-emitter cut-off current	$V_{CE}=650V, V_{GE}=0V$ $T_{vj}=25^\circ C$ $T_{vj}=175^\circ C$	I_{CES}		2400	50	μA
Gate-emitter leakage current	$V_{CE}=0V, V_{GE}=20V$ $T_{vj}=25^\circ C$	I_{GES}			100	nA

Turn-on delay time	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	t _{d on}		34		
		T _{vj} =125°C			37		
		T _{vj} =150°C			40		
Rise time	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	t _r		153		ns
		T _{vj} =125°C			157		
		T _{vj} =150°C			163		
Turn-off delay time	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	t _{d off}		183		
		T _{vj} =125°C			198		
		T _{vj} =150°C			208		
Fall time	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	t _f		67		
		T _{vj} =125°C			68		
		T _{vj} =150°C			73		
Turn-on energy loss per pulse	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	E _{on}		4.28		mJ
		T _{vj} =125°C			4.35		
		T _{vj} =150°C			4.57		
Turn-off energy loss per pulse	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	E _{off}		1.08		mJ
		T _{vj} =125°C			1.12		
		T _{vj} =150°C			1.20		
Total switching energy	I _C =75A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C	E _{ts}		5.36		
		T _{vj} =125°C			5.47		
		T _{vj} =150°C			5.77		

Diode

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse Voltage	T _{vj} =25°C	V _{RRM}	650	V
Continuous DC forward current	T _C =25°C, T _{vj max} =175°C	I _F	80	A
	T _C =100°C, T _{vj max} =175°C		75	
Diode pulsed current, tp limited by T _{vj max}		I _{Fpuls}	180	A

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit		
			Min.	Typ.	Max.			
Forward Voltage	I _F =75A, V _{GE} =0V	V _F			1.48	2.0	V	
					T _{vj} =125°C			1.61
					T _{vj} =150°C			1.62
Peak reverse recovery current	I _F =75A, -di _F /dt=460A/μs(T _{vj} =150°C) V _R =400V, V _{GE} =-15V	I _{RM}			17		A	
					T _{vj} =25°C			23
					T _{vj} =150°C			25

Reverse Recovered charge	$I_F=75A,$ $-di_F/dt=460A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	Q_{rr}		2.43 3.37 3.72		μC
Reverse Recovery Time	$I_F=75A,$ $-di_F/dt=460A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	t_{rr}		200 211 227		ns
Reverse recovered energy	$I_F=75A,$ $-di_F/dt=460A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	E_{rec}		0.68 0.91 0.99		mJ

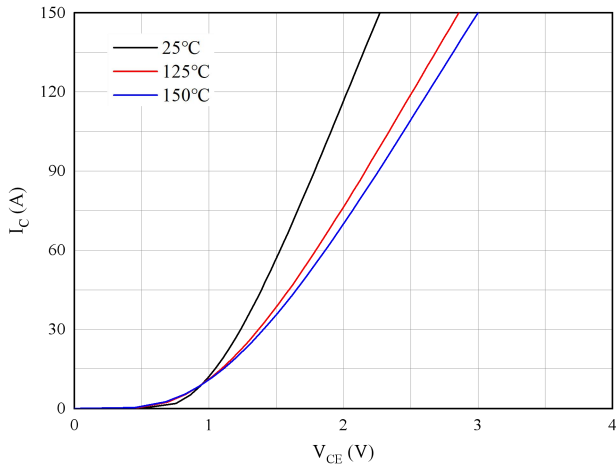


Fig 1. Typical output characteristics ($V_{GE}=15V$)

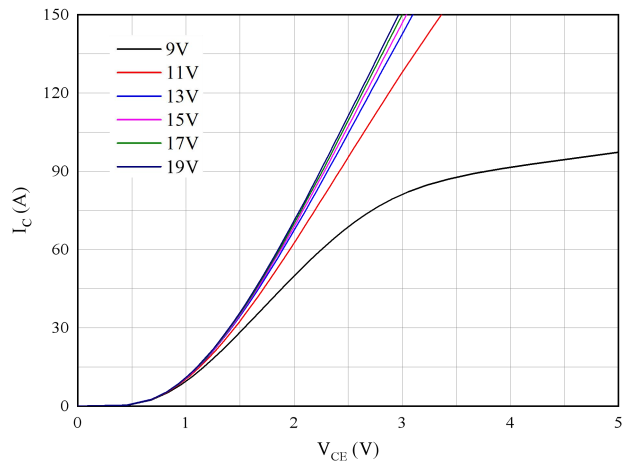


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

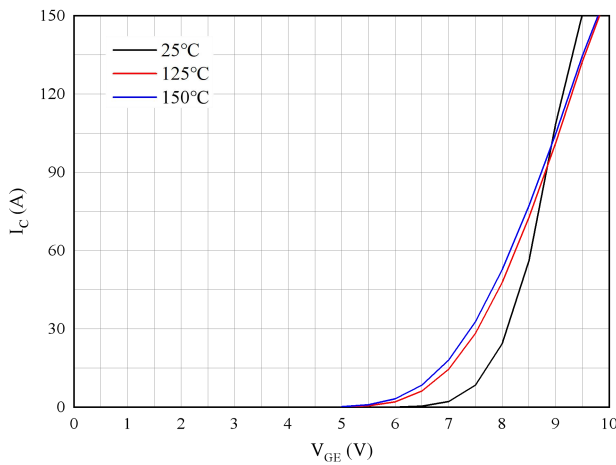


Fig 3. Typical transfer characteristic ($V_{CE}=20V$)

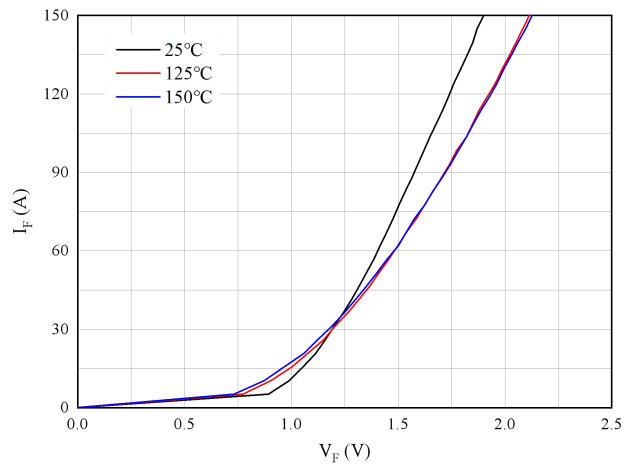


Fig 4. Forward characteristic of Diode

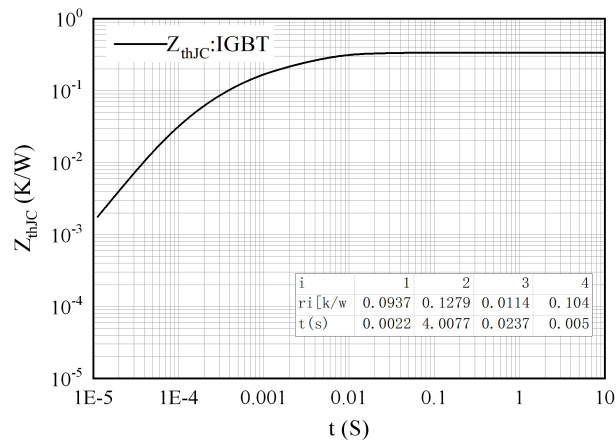


Fig 5. Transient thermal impedance IGBT,
 $Z_{thJC}=f(t)$

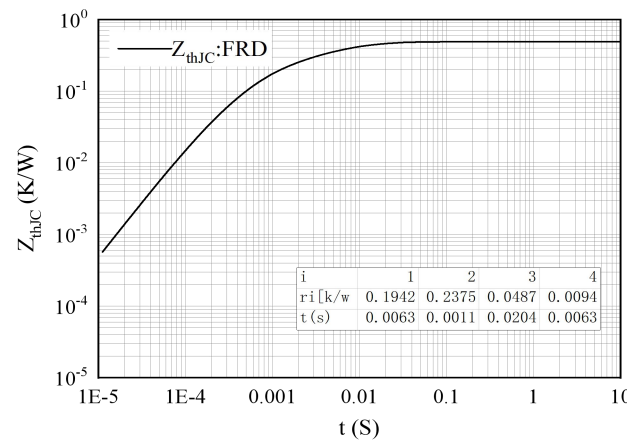


Fig 6. Transient thermal impedance FRD,
 $Z_{thJC}=f(t)$

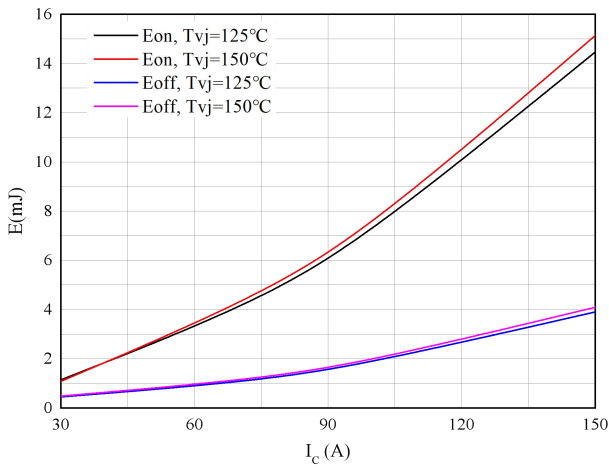


Fig 7. Switching losses of IGBT
 $V_{GE} = \pm 15\text{V}$, $R_{Gon} = 8\Omega$, $R_{Goff} = 8\Omega$, $V_{CE} = 400\text{V}$

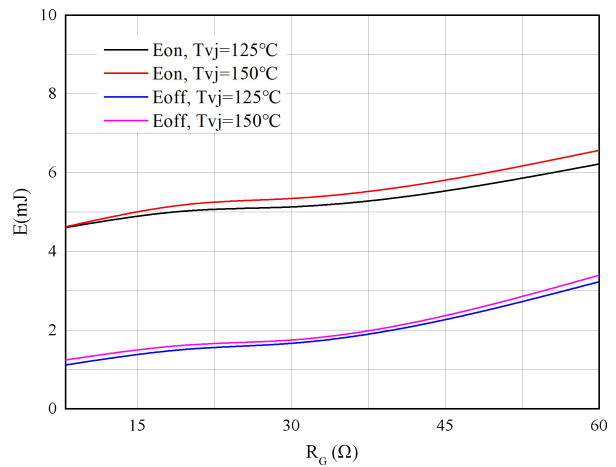


Fig 8. Switching losses of IGBT
 $V_{GE} = \pm 15\text{V}$, $I_c = 75\text{A}$, $V_{CE} = 400\text{V}$

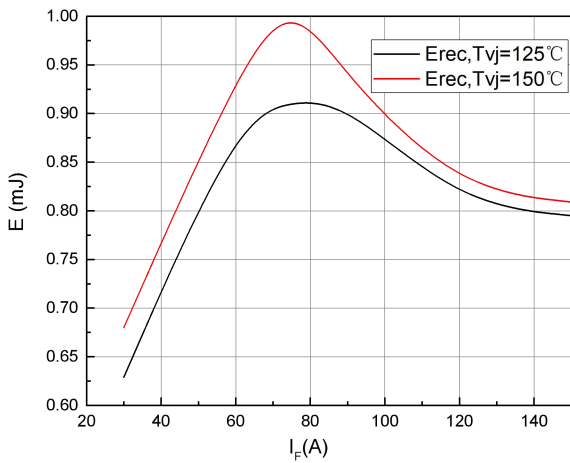


Fig 9. Switching losses of Diode
 $R_{gon} = 8\Omega$, $V_{CE} = 400\text{V}$

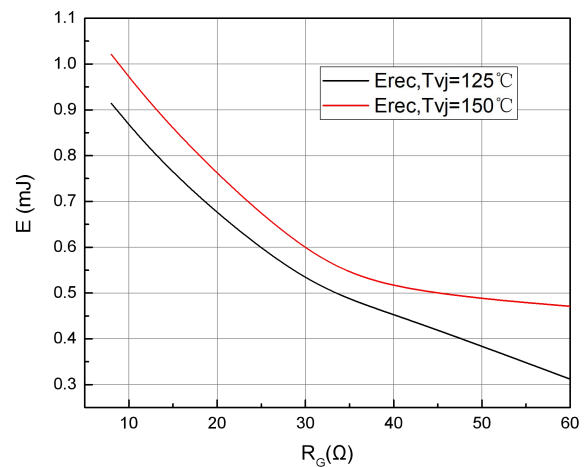


Fig 10. Switching losses of Diode
 $I_f = 75\text{A}$, $V_{CE} = 400\text{V}$

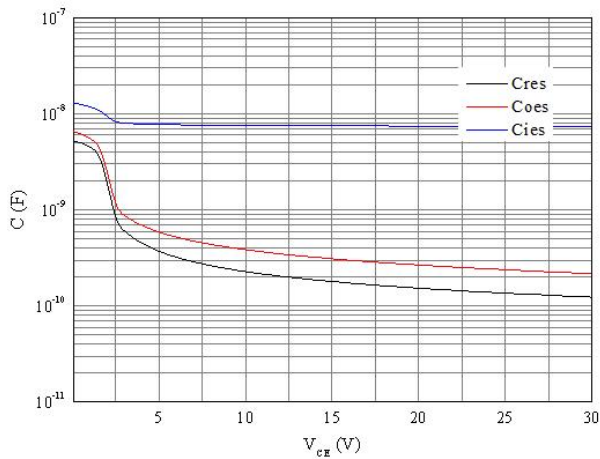
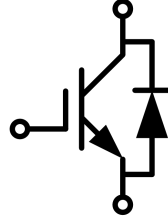
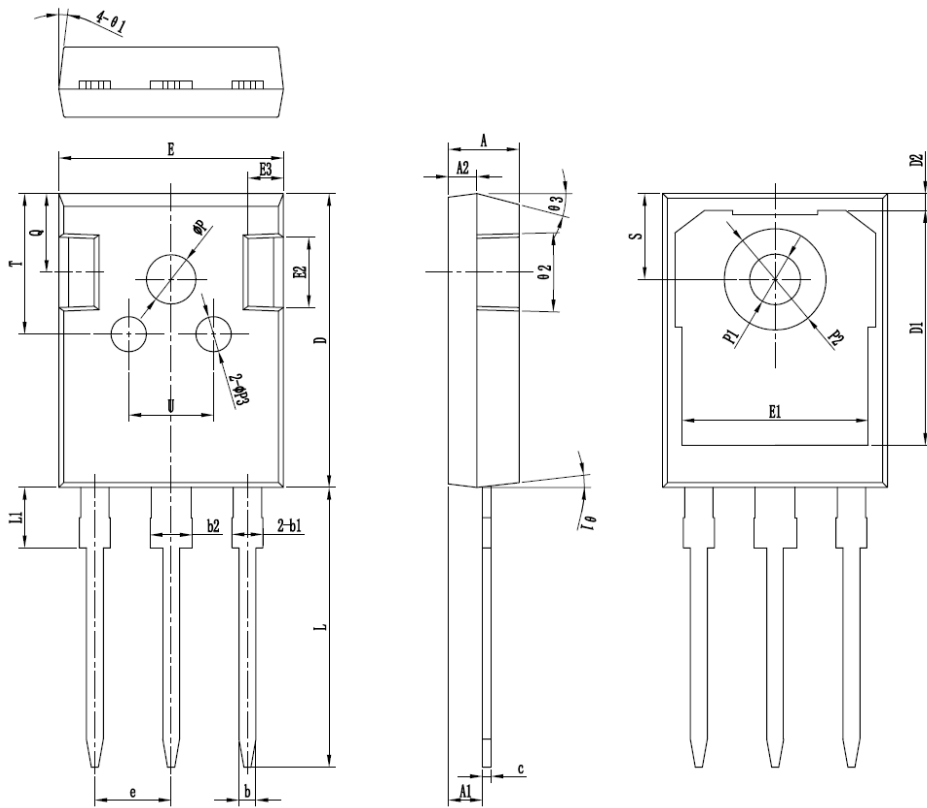


Fig 11. Capacitance characteristic

Circuit diagram



Package outlines



symbol	unit: mm		
	MIN	NOM	MAX
#A	4.90	5.00	5.10
#A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
#B	1.15	1.20	1.25
#B1	1.95	2.10	2.25
#B2	2.95	3.10	3.25
#C	0.65	0.60	0.65
#D	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35
#E	15.70	15.80	15.90
E1	13.10	13.25	13.40
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
#F	5.40	5.44	5.48
#L	19.80	19.92	20.10
#L1	-	-	4.30
#P	3.70	3.80	3.90
#P1	3.50	3.60	3.70
#P2	7.00	7.20	7.40
#P3	2.40	2.50	2.60
Q	5.60	5.80	6.00
#S	6.05	6.15	6.25
T	9.80	10.00	10.20
U	6.00	6.20	6.40
Ø1	5*	7*	9*
Ø2	1*	3*	5*
Ø3	13*	15*	17*